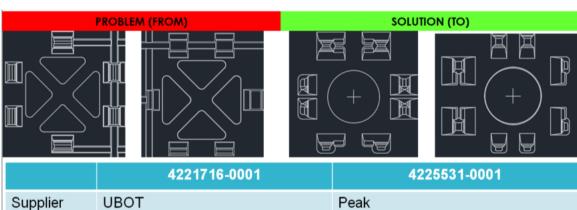
PCN Number: 20200814001.2				.2	F		PCN Date:		Sept. 14, 2020		
Title: New Tray for Select Devices											
Customer Contact:	PCN Manager				Dept:			Quality Services			
Proposed 1 st Ship Date: Mar.			14,	2021							
Change Type:											
Assembly Site				Design			☐ Wafer Bump Site				
Assembly Process				Data Sheet			☐ Wafer Bump Material				
Assembly Materials				Part number change			Wafer Bump Process				
Mechanical Specification				Test Site				Wafer Fab Site			
Packing/Shipping/Labeling				Test Process				Wafer Fab Materials			
☐ Wafer Fab Process											
PCN Details											

Description of Change:

Texas Instruments is pleased to announce the qualification of a new tray for the devices listed below. A comparison summary of the tray differences as follows:

Tray Comparison Tables:



	4221716-0001	4225531-0001
Supplier	UBOT	Peak
Cavity size (live bug)	17.3	17.4
Seating ht	1.75 (Top) 0.65 (Bottom)	1.49 (Top) 1.19 (Bottom)

Engineering Validation Results – 17x17 PBGA

	CUR	RENT T	'RAY	PROP	OSED T	RAY		
Items	4221716-0001			4225531-0001			REMARKS	
Description	DIM	MAX	MIN	DIM	MAX	MIN	KEWAKKS	
Overall Length	322.6	322.85	322.35	322.6	322.85	322.35	NO CHANGE	
Layout Length	315.0	315.25	314.75	315.0	315.25	314.75	NO CHANGE	
Layout Width	135.9	136.15	135.65	135.9	136.15		NO CHANGE	
Layout Length on Top Stack frame	311.15	311.40	311.02	311.15	311.40		NO CHANGE	
Layout Width on Top Stack frame	132.08	132.33	131.95	132.08	132.33	131.95	NO CHANGE	
Layout Length on Bottom Stack frame	311.66	311.91	311.53	311.66	311.91	311.53	NO CHANGE	
Layout Width on Bottom Stack frame	132.59	132.84	132.46	132.59	132.84	132.46	NO CHANGE	
End Tab Length	92.1	92.35	91.85	92.1	92.35	91.85	NO CHANGE	
Overal Height	7.62	7.75	7.49	7.62	7.75	7.49	NO CHANGE	
Stack Height	1.27	1.40	1.14	1.27	1.40	1.14	NO CHANGE	
Tray Matrix No.		6x15			6x15		NO CHANGE	
Pitch M	19.20	19.33	19.07	19.20	19.33	19.07	NO CHANGE	
Pitch M3	19.50	19.63	19.37	19.50	19.63	19.37	NO CHANGE	
Pitch M1	21.00	21.13	20.87	21.00	21.13	20.87	NO CHANGE	
Pitch M2	19.50	19.63	19.37	19.50	19.63	19.37	NO CHANGE	
Cavity Size - Live Bug	17.30	17.4	17.2	17.40	17.48	17.32	CHANGE	
Cavity Size - Dead Bug	17.30	17.38	17.22	17.30	17.38	17.22	NO CHANGE	
Package seating height (Top)	1.75	1.83	1.67	1.49	1.59	1.39	CHANGE	
Package seating height (Bottom)	0.65	0.73	0.57	1.19	1.29	1.09	CHANGE	

Reason for Change:

New tray offers improved centering of device in tray pocket

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

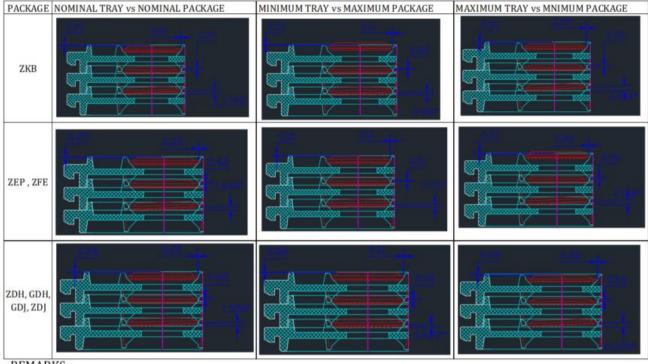
Changes to product identification resulting from this PCN:

New tray

Product Affected:

D710E001BZDHA275	D810K003DZKBT400	TMS320C28343ZFEQ
D710E002BZDHA275	S570PSFC62CZFEQQ1	TMS320C28346ZFEQ
D790E001BZDHA275	SM320C6727BGDHMEP	V62/11617-01XF

Fit Analysis:



REMARKS:

- · X and Y clearance is less than 0.5 mm
- Rotation angle is less than 10 degrees

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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